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REGISTRATION

At least one of the authors of accepted paper should register for conference and present the paper. Payment details for registration are given below.

Bank Details for Registration:

Account Name: VFSTR MISCELLANEOUS
Bank Account Number: 21890210000151
Bank Name: UCO Bank
Bank Branch: Vadlamudi
IFSC Code:UCBA0002189

REGISTRATION FEE DETAILS

Participation From Industries	: Rs. 10,000/-
Participation From External Academicians	: Rs. 8,500/-
Participation From Internal Academicians	: Rs. 8,000/-

ELIGIBILITY

Researchers, Faculty, Research Scholars, UG & PG students from various institutions and organizations can participate. Accommodation can be provided at University campus on prior request on payment basis.

PAPER SUBMISSION AND SCHEDULED DATES:

Authors are requested to prepare the paper as per template given in the below link.

<http://www.tjprc.org/page.php?pid=37&year=2018&jtype=2&id=67>

Important Dates:

Last date for Full length paper submission	: 20-07-2018
Intimation of selection (To be intimated by mail only)	: 30-07-2018
Last date for Registration	: 10-08-2018

Note: Physically presented papers will be published in Scopus Journal.

Application form completed in all respects is to be sent to:

The Conference Convener

"ADVANCES IN MODELING, MANUFACTURING AND MATERIALS ENGINEERING"

Department of Mechanical Engineering,

Vignan's Foundation for science and Technology Research (VFSTR), Vadlamudi,Guntur,Andhra Pradesh-522213

Mobile No: 9440144598 & 9666079790

E-Mail: kvenkatrama@gmail.com,nandurerao@gmail.com

NCAMMM - 2K18

National Conference
on

"ADVANCES IN MODELING, MANUFACTURING AND MATERIALS ENGINEERING"

Date:17-18 August 2018



VIGNAN'S

Foundation for Science, Technology & Research

(Deemed to be UNIVERSITY)

-Estd. u/s 3 of UGC Act 1956

Organized by
Department of Mechanical Engineering
VFSTR

(Deemed to be University)

Vadlamudi, Guntur(Dt) - 522 213, A.P., India
Contact: e-mail : hodmech@vignanuniversity.org

ABOUT THE VFSTR

Vignan Foundation for Science, Technology & Research Deemed to be University is located in the serene environs of Vadlamudi on the guntur- Tenali highway, about 14km from Guntur and 11km from Tenali. The University is a virtual heaven of rural quiet and idyllic beauty. The splendid avenue, imposing buildings and sprawling play grounds, and the verdure in and around the campus make it one of the most preferred choices for the aspirants of Engineering studies. Since its inception in 1997, the institution has been striving to promote high standards in technical education to aid in the career building of the many students who step into its portals. Vignan's impressive academic credentials stand a testimony to its commitment to offer quality education. The University campus is Wi-Fi enabled and connected to external world through National Knowledge Network (NKN).

ABOUT DEPARTMENT OF MECHANICAL ENGINEERING

The department of Mechanical Engineering, established in the year 1997. The department takes responsibility in organizing guest lectures, seminars, workshops and training programs with the help of engineers and academicians of national and international repute to help students, research scholars and faculty members to keep abreast with the latest developments in the field of Mechanical Engineering. Students are made to embolden future technology by encouraging them to think futuristic by catalyzing research and research related activities through the Research and Development (R&D) cell. As a result of the department's forthright Research activities, numerous students from the Department of Mechanical Engineering have placed their foot prints in many International and National Companies.

Under Graduation

Mechanical Engineering

Post Graduation

- Machine Design ■ Thermal ■ CAD/CAM/CAE

About the Conference

The Conference is aimed at providing a platform to exchange advanced and contemporary research ideas of researchers, academicians, students and industry personal.

Special invited lectures by experts from reputed institutions will definitely enlighten the conference participants in the current research areas.

The scope of the conference includes all theoretical, practical and technical advances in the following topics. (but not limited).

Call for Papers:

The conference focuses on the following Areas:

- Advanced Composite Materials
- Design & Optimization
- Industrial Engineering
- Materials Science and Metallurgy
- MEMS & Mimics
- Mechatronics & Robotics
- Production Processes
- Nano Technology
- 3D Printing & Rapid Prototyping
- Renewable Energy Sources
- Fluid Mechanics & Thermal Engineering
- Tribology & Surface Engineering

REGISTRATION FORM

"ADVANCES IN MODELING, MANUFACTURING AND MATERIALS ENGINEERING (NCAMMM-2K18)"

2018-19

Name: _____

Age: _____ Sex: Male Female

Designation: _____

Official Address: _____

Phone No. with STD Code: _____

e-mail: _____

Mobile No. _____

Whether Accommodation Required: Yes No

Details of payment.

Transaction ID No. _____

Signature of the Applicant

Signature of the Sponsoring

Authority with office Seal

Date:

Place: